Specification

Drawing No.	TNY1T-H1-16557-00 [1/10]
Issued Date.	Jul-27-2016

TO: AVX Corporation

Note: In case of specification change, KYOCERA Part Number also will be changed.

Product Name	Crystal Oscillator
Product Model	
Frequency	30 MHz
Customer Part Number	
Customer Specification Number	
KYOCERA Part Number	MC2016K30.0000C16ESH
Remarks RoHS Compliant / MSI	1 / AEC-Q200 & Q100 Certified

Customer Acceptance

Accept Signature	Accept Date	
	Department	
	Person in charge	

KYOCERA Crystal Device Corporation

Head Office 5850, Higashine-koh, Higashine-shi, Yamagata 999-3701 Japan TEL. No. (+81)237-43-5611 FAX. No. (+81)237-43-5615

Sales Division

6 Takeda Tobadono-cho, Fushimi-ku, Kyoto 612-8501 Japan TEL. No. (+81)75-604-3500 FAX. No. (+81)75-604-3501

Design Department	Quality Assurance	Approved by	Checked by	Issued by
KYOCERA Crystal Device Corporation Oscillator Division	M. Fukawa	H.Yotsuzuka	M. Ishibashi	K.Shimura

Revision History

Rev. No.	Description of revise	Date	Approved by	Checked by	Issued by
00	First Edition	Jul-27-2016	H.Yotsuzuka	M. Ishibashi	K.Shimura
			- 7		
			Y		
	-				

Drawing No.	TNY1T-H1-16557-00 [3/10]
Drawing No.	

6

1. Scope

This specification shall be defined of the Clock Oscillator for the integrated circuits (ICs).

2. Customer Part Number

3. KYOCERA Part Number

MC2016K30.0000C16ESH

4. Electrical Characteristics

4-1. Absolute Maximum Rating

Item	Symbol	Rated Value	Units
Power Supply Voltage	V _{CC}	-0.3 to +4.0	V
Input Voltage	V _{IN}	-0.3 to V _{CC} +0.3	V
Storage Temperature	T _{STG}	-55 to +125	ç

Note:

If the part is used beyond absolute maximum ratings, it may cause internal destruction. The part should be used under the recommended operating conditions the reliability of this part may be damaged if those conditions are exceeded.

4-2. Recommended Operating Conditions

Item	Symbol	Min	Тур	Max	Units	Remarks
Power Supply Voltage	V _{CC}	1.6	3.3	3.63	V	
Input Voltage	V _{IN}	0		V _{CC}	V	
Operating Temperature	T _{OPR}	-40	+25	+105	°C	

4-3. Electrical Characteristics

4-5. Liectifical Gharacteristics								
Item	Symbol	Min	Тур	Max	Units	Remarks		
Output Frequency	Fo		30		MHz			
Frequency Tolerance*	F_tol	-50		+50	ppm			
Current Consumption (Loaded/ 1.6≤V _{CC} ≤2.25V)				3.5				
Current Consumption (Loaded/ 2.25 <v<sub>CC≤2.8V)</v<sub>	I _{CC}			4.5	mA	Y		
Current Consumption (Loaded/ 2.8 <v<sub>CC≤3.63V)</v<sub>				5.0				
Standby Current	I _{ST}			5	μA			
Symmetry (Duty Ratio)	SYM	45	50	55	%	@ 50% V _{CC}		
Rise Time/ Fall Time				6.0		1.6≤V _{CC} ≤2.25V		
$(10\% V_{cc} \text{ to } 90\% V_{cc})$	Tr/ Tf			5.0	ns	2.25 <v<sub>CC≤2.8V</v<sub>		
				4.5		2.8 <v<sub>CC≤3.63V</v<sub>		
Output Voltage-"L"	V _{OL}		/	10% V _{CC}	V	I _{OL} = 4mA		
Output Voltage-"H"	V _{OH}	90% V _{CC}			•	I _{OH} =-4mA		
Output Load	CL			15	pF	CMOS		
Input Voltage-"L"	VIL			$30\% V_{CC}$	V			
Input Voltage-"H"	VIH	70% V _{CC}			v			
Output Disable Time	t _{dis}			200	ns			
Output Enable Time	t _{ena}			5	ms			
Start-up Time	t_ _{sta}			5	ms	@Minimum operating voltage to be 0sec		
1 Sigma Jitter**	J _{Sigma}			5	ne			
Peak to Peak Jitter**	Јрк-рк			50	ps			
Phase Jitter				1	ps	BW:12kHz to 20MHz		

Note: All electrical characteristics have defined on the maximum loaded and recommended operating conditions.

* Include initial tolerance, operating temperature range, rated power supply voltage change, load change, aging (1year @+25°C), shock and vibration **Based on Time Interval Analyzer "Wavecrest SIA-3000".

Table 1

Drawing No. TNY1T-H1-16557-00 [4/10]

4-4. Measurement Condition

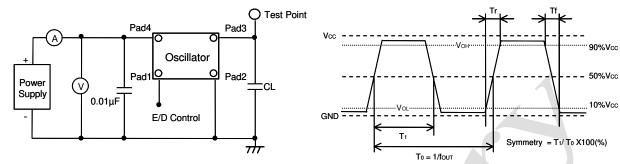
The reference temperature shall be $+25\pm2^{\circ}C$. The measurement shall be performed at the temperature range of $+5 \,^{\circ}C$ to $+35 \,^{\circ}C$ unless otherwise the result is doubtful.

4-5. Measurement Circuit

The electrical characteristics shall be measured by test circuit "Fig. 1". Also jitter shall be measured by test circuit "Fig. 3".

4-6. Clock Timing Chart

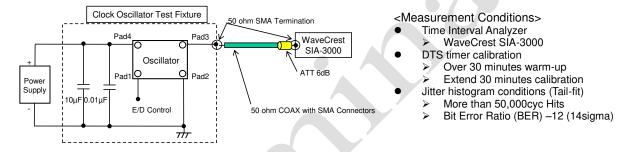
The clock timing chart is "Fig. 2".



Note: CL includes probe and test fixture capacitance



Fig.2 Clock Timing Chart (C-MOS Output)





5. Dimensions and Marking 1.2 2.0Output Frequency #3 #4 30.0 0.0 Marking Area Pad1 Indication Q Manufacturing Date Code 0.6 **Output Frequency** #1 #2 The output frequency is three-digit without a decimal point. The frequency greater than the number of digits Max have rounded down. 0.8 (E.g. 14.31818MHz → "14.3") Manufacturing Date Code 2 Year Code R М NI Plating Ni+Au Ν Tolerance: +/-0.2 D Unit:(mm) F 0 F R 16 Pad arrangement Enable/Disable Function G 18 Н 8 Enable/Disable Pad1 Pad3 (Output) W 9 19 OPEN Case GND 2 Active Κ 10 Α 30 2020 Х В 11 31 3 Output "H" Level Active repeats from A in 2021 ar erw ards 12 Vcc High Z (No-Oscillation) 4 'L" Level e.g. :"P4A" means "Apr-10-2014

Table 2

6. Parts Numbering Guide

<u>MC2016K30.0000</u> <u>C</u> <u>1</u> <u>6</u> <u>E</u> <u>SH</u> A B C D E F G

- A. Series (SMD Oscillator)
- Β. **Output Frequency**
- C. Output

17

18

19

ESD

Solderability

Characterization

Electrical

- C: C-MOS Supply Voltage D
- 1: 1.8V/ 2.5V/ 3.3V Compatible
- E. Frequency Tolerance* 6: ±50ppm

- F. Symmetry (Duty Ratio) and Enable/Disable Function E: Symmetry: 45% to 55% with Stand-by Function
- G. For Automotive

Packing (Tape & Reel 2,000pcs/Reel)

*Over All Conditions:

Include initial tolerance, operating temperature range, rated power supply voltage change, load change, aging (1year @+25°C), shock and vibration

Satisfy Electrical

Dipped potion: Minimum

Satisfy Approval Sheet

Characteristics.

95% coverage

15

15

30 x 3Lot

7. Environmental Characteristics

AEC-Sample Q200 Items Conditions Reference **Criteria of Acceptance** Size No [PCS] **High Temperature** MIL-STD-202 Satisfy Electrical 3 +125°C 1000 hrs. Unpowered. 77 Exposure (Storage) Method 108 Characteristics. JESD22 Method Satisfy Electrical 4 **Temperature Cycling** 1000cycles (-55 to +125°C) 77 Characteristics. JA-104 +25°C, +65°C 90%RH Satisfy Electrical 10cycles 24 hrs/1cycle. MIL-STD-202 Characteristics. 6 Moisture Resistance 77 Unpowered. Method 106 Clause 13 shall be also Steps 7a & 7b not required. satisfied. MIL-STD-202 +85°C, 85%RH, 1000 hrs. Satisfy Electrical 7 77 **Biased Humidity** V_{CC}=3.63V, CL=15pF Method 103 Characteristics. +125°C, 1000 hrs. MIL-STD-202 Satisfy Electrical 77 8 **Operational Life** V_{CC}=3.63V, CL=15pF Method 108 Characteristics. Thing that abnormality is not found in externals. MIL-STD-883 (Inspect device 9 External Visual Magnification 10x 30 Method 2009 construction, marking and workmanship. Electrical Test not required.) JESD22 Method 10 **Physical Dimension** Satisfy Approval Sheet 30 JB-100 Resistance to MIL-STD-202 Thing that abnormality is 12 Magnification 10x 5 Solvents not found in externals. Method 215 100G/6ms/Half-sine Velocity MIL-STD-202 Satisfy Electrical 13 Mechanical Shock 30 change 12.3 (Vi)ft/sec Method 213 Characteristics. 10 to 2000Hz. 5g's for 20 MIL-STD-202 Satisfy Electrical 14 Vibration minutes 12 cycles each of 3 30 Method 204 Characteristics. orientations. Resistance to MIL-STD-202 Satisfy Electrical 15 Soaking:+260±5°C, 10±1sec 30 Soldering Heat Method 210 Characteristics. -55°C/+125°C. 300Cycles, MIL-STD-202 Satisfy Electrical Thermal Shock Max. transfer time 20 sec. 30 16 Method 107 Characteristics. Dwell time 5 min. Air-Air. Human Body Model:

7-1. Environmental Characteristics (Based on AEC-Q200 Rev. D)

100pF/1500ohm/500~2000V

8 hrs. steam age +215°C

solder temperature 5 second

5 pulses

dwell

AEC-Q200-002

Approval Sheet

J-STD-002

Drawing No.

TNY1T-H1-16557-00 [6/10]

AEC- Q200 No	Items	Conditions	Reference	Criteria of Acceptance	Sample Size [PCS]
21	Board Flex	It pressurizes in the direction of the arrow, it pressurizes at the speed of 2mm in bend width about 0.5mm/sec, and it maintains it for 60 seconds.	AEC-Q200-005	Satisfy Electrical Characteristics. Without looseness or crack etc.	30
22	Terminal Strength (SMD)	The static load of 1.8Kg is added in the direction of the arrow and it maintains it in the prime fields of parts for 60 sec with a scratch treatment device of R0.5.	AEC-Q200-006	Satisfy Electrical Characteristics. Without looseness or crack etc.	30

After above test, measurement shall be done after leaving sample in room temperature for 2 hours.

Table 3

7-2 Based on AEC-Q100 Rev. G TEST GROUP A

AEC- Q100 ABV	Stress	Reference	Criteria of Acceptance	Sample Size [PCS]
PC	Preconditioning	JESD22 A113 J-STD-020	Satisfy Electrical Characteristics.	77
THB or HAST	Temperature-Humidity-Bias or Biased HAST	JESD22-A101 or 110	AEC-Q200 Biased Humidity	77
AC or UHST or TH	Autoclave or Unbiased HAST or Temperature-Humidity (without Bias)	JEDEC JESD22-A102,118 or A101	AEC-Q200 Biased Humidity Test	77
TC	Temperature Cycling	JESD22-A104	AEC-Q200 Temperature Cycling	77
PTC	Power Temperature Cycle	JESD22-A105	N/A Max rated power is under 0.1W.	-
HTSL	High Temperature Storage Life	JESD22-A103	Satisfy Electrical Characteristics.	45

Table 4

TEST GROUP B

AEC- Q100 ABV	Stress	Reference	Criteria of Acceptance	Sample Size [PCS]
HTOL	High Temperature Operating Life	JESD22- A108	AEC-Q200 Operational Life	77
ELFR	Early Life Failure Rate	AEC Q100-008	Satisfy Electrical Characteristics	800
EDR	NVM Endurance, Data Retention, and Operational Life	AEC Q100-005	NA IC without memory, not applicable	

Table 5

TEST GROUP C

AEC- Q100 ABV	Stress	Reference	Criteria of Acceptance	Sample Size [PCS]
ALL GROUP C			NA Not Wire Bonding	
		Table 6		

Table 6

TEST GROUP D (Compatible IC MAKER DATA)

AEC- Q100 ABV	Stress	Reference	Criteria of Acceptance	Sample Size [PCS]
EM	Electromigration	JESD61	Process Data	
TDDB	Time Dependent Dielectric Breakdown	JESD35	Process Data	
HCI	Hot Carrier Injection	JESD60 & 28	Process Data	
NBTI	Negative Bias Temperature Instability	JESD90	N/A	
SM	Stress Migration	JESD61,87 & 202	Process Data	

Table 7

TEST GROUP E

AEC- Q100 ABV	Stress	Reference	Criteria of Acceptance	Sample Size [PCS]
TEST	Pre- and Post-Stress Function/Parameter	Specification	0 fails	ALL
HBM / MM	Electrostatic Discharge Human Body Model / Machine Model	AEC Q100-002 Q100-003	HBM Over 2KV MM Over 200V	18
CDM	Electrostatic Discharge Charged Device Model	AECQ100-011	0 Fails 750V corner pins, 500V all other pins	6
LU	Latch-Up	AECQ100-004	0 fails	6
ED	Electrical Distributions	AECQ100-009	Satisfy Electrical Characteristics	30
FG	Fault Grading	AECQ100-007	NA	
CHAR	Characterization	AEC Q003	AEC-Q200 acceptable	
GL	Electrothermally-Induced Gate Leakage	AECQ100-006	NA	
EMC	Electromagnetic Compatibility	SAE J1752/3	For Information only	6
SC	Short Circuit Characterization	AEC Q100-012	N/A	
SER	Soft Error Rate	JESD89-1 or JESD89-2 & JESD89-3	NA Non Volatile Memory IC	

Table 8

TEST GROUP F

AEC- Q100 ABV	Stress	Reference	Criteria of Acceptance	Sample Size [PCS]
PAT	Process Average Testing	AEC Q001	For Information only	ALL
SBA	Statistical Bin/Yield Analysis	AEC Q002	For Information only	ALL
	-			

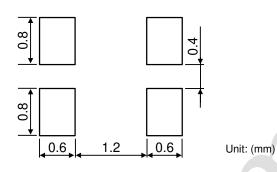
Table 9

TEST GROUP G

AEC- Q100 ABV	Stress	Reference	Criteria of Acceptance	Sample Size [PCS]
MS	Mechanical Shock	JESD22-B104	AEC-Q200 Mechanical Shock	39
VFV	Variable Frequency Vibration	JESD22-B103	AEC-Q200 Vibration	39
CA	Constant Acceleration	MIL-STD-883 Method 2001	Satisfy Electrical Characteristics	39
GFL	Gross/Fine Leak	MIL-STD-883 Method 1014	Satisfy Electrical Characteristics	39
DROP	Package Drop		NA NOT MEMS	
LT	Lid Torque	MIL-STD-883 Method 2024	Over 0.5N-m	5
DS	Die Shear	MIL-STD-883 Method 2019	For Information only	5
IWV	Internal Water Vapor	MIL-STD-883 Method 1018	Satisfy Electrical Characteristics	3

Table 10

8. Recommended Land pattern and Soldering Guide

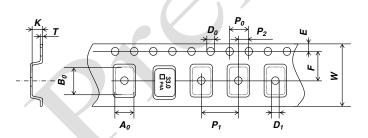


Note:

Since the part doesn't have Bypass Capacitor between $V_{\rm cc}$ and GND, Please mount high frequency type capacitor $0.01 \mu F$ to the nearest position of oscillator.

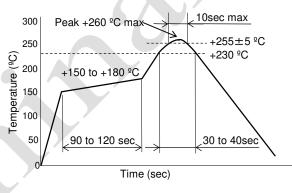
Fig.4 Land pattern

9. Taping Specifications



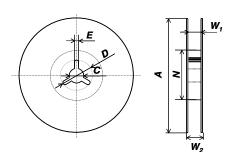
				U	nit: (mm)
Symbol	A ₀	B ₀	W	F	Ε
Dimensions	1.8±0.1	2.25±0.1	8.0±0.2	3.5±0.05	1.75±0.1
Symbol	P ₁	P ₂	P ₀	D ₀	Т
Dimensions	4.0±0.1	2.0±0.05	4.0±0.1	1.5+0.1/-0	0.2±0.05
Symbol	K	D ₁			
Dimensions	0.9±0.1	1.1±0.1			

Fig.6 Emboss Carrier Tape



• Available Reflow times: Maximum twice

Fig.5 Reflow profile (Lead Free Available)



			Unit: (mm)
Symbol	A	N	<i>W</i> ₁
Dimensions	180 +0/-1.5	60+1/-0	9.0+0.3/-0
Symbol	<i>W</i> ₂	С	D
Dimensions	11.4±1.0	13.0±0.2	21.0±0.8
Symbol	E		
Dimensions	2.0±0.5		

Fig.7 Reel

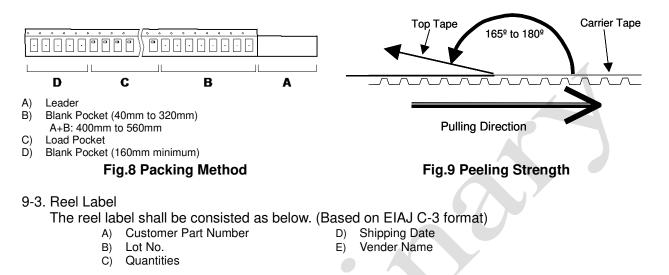
Drawing No.	TNY1T-H1-16557-00 [9/1	0]
- J		· ·

9-1. Taping Quantities

- The taping of per reel shall be packed 2,000 pcs.
- The parts shall be contained continuously in the pocket.

9-2. Leader and Blank Pockets

- The package shall be consisted of leader, blank pockets and loaded pocket as follows "Fig. 8".
- The power of peeling strength between top tape and carrier tape shall be 0.1N(10gf) to 0.7N(70gf) as follows "Fig. 9".



9-4. Exterior Package Label

The oscillator shall be packed properly to avoid defect in transportation. The exterior package label shall be consisted as below.

- A) Name of Customer
- B) P/O No.
- C) Customer Part Number
- D) Lot No.

- E) Quantities
- F) Shipping Date
- G) Vender Name

Drawing No.	TNY1T-H1-16557-00 [10/10]	

10. The agreement of this specifications

In case there is any obscure point or doubt concerning the contents of the specification, it shall be settled through consultation of both parties.

11. Remarks on Usages

A) Storage Conditions

The parts shall be stored in temperature range of -5 to +40°C, humidity 40 to 60% RH, and avoid direct sunlight. Then the parts shall be used within 6 months.

B) Handling Conditions

Although the part has protection circuit against static electricity, when excess static electricity is applied, the inside IC may get damaged.

Before mounting on the PCB, please make sure the direction of the part is correct. Otherwise the part of temperature will increase. And also the part will have some damages.

Please do not use the parts under the unfavorable condition such as beyond specified range in this specification.

Please do not use the parts under the condition, in the water or in the salt water also environment of dew or harmful gas.

Please make sure the condition of pick and place following pick up nozzle guideline.

Picking Method: Case of Head Unit 1.6 x 1.2mm (Inside Diameter)

The proper condition of pick and place will be different each equipment. Therefore, please check before testing.

C) Rework Condition

Please do not pick up Head Unit. We can't guaranty electrical performance and reliability.

- D) Soldering Conditions This product can respond to the general Pb-free reflow profile. The wave soldering cannot be supported.
- E) Soldering in Mounting

In case of Solder paste and conductive glue contact product lid or product side face exception for product terminal it's possible to influence product characteristics. Please be careful above contents.

F) Washing Conditions

Ultra sonic cleaning is available. However there is a possibility that Crystal in the part may cause damaged under certain condition. Therefore please test before using.

After washing, please dry the parts completely. Otherwise water drops between the parts and PCB may cause migration.

In case of using this part without above precaution, Kyocera is unable to guarantee the specific characteristics.